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Sub B1

1. A resistor having a resistance that can be adjusted by current being passed there through and which is formed as part of a semiconductor device comprising:

a polycrystalline silicon resistor formed of on a layer, wherein said polysilicon resistor is formed using a doping wherein said doping has a concentration of from $\sim 6 \times 10^{19} \text{ cm}^{-3}$ to $\sim 3.75 \times 10^{20} \text{ cm}^{-3}$.

2. A resistor having a resistance that can be adjusted by current being passed there through and which is formed as part of a semiconductor device comprising:

a polycrystalline silicon resistor formed of on a layer, wherein said polysilicon resistor is formed using a doping wherein said doping has a concentration of less than $\sim 3.75 \times 10^{20} \text{ cm}^{-3}$.

3. A method of making a polysilicon resistor comprising the steps of:
providing a substrate,
depositing a polycrystalline layer on said substrate,
aligning and exposing a poly resistor mask,
poly doping the polycrystalline layer,
forming an insulating oxide,
aligning and exposing the mask for the resistor,
depositing an inter level dielectric,
annealing the inter level dielectric, and
completing the processing using low temperature processing.

1 4. A method as in Claim 3 wherein said first annealing step occurs at
2 or below 900 °C .

1 5. A method as in Claim 3 wherein said formation of said insulating
oxide occurs at or below 950 °C .

6. A method as in Claim 3 wherein said ion implantation to provide
the poly doping results in a concentration of $\sim 6 \times 10^{19} \text{ cm}^{-3}$ to $\sim 3.75 \times 10^{20} \text{ cm}^{-3}$

7. A method of trimming a polysilicon resistor to a target resistance
formed using a low concentration doping comprising the steps of:
passing an electrical signal through said resistor,
measuring and increasing said passed electrical signal until the
resistance of said resistor equals the target resistance.

8. A method of trimming a polysilicon resistor to a target resistance
formed using a low concentration doping, as in claim 7 wherein the step of
passing an electrical signal is by way of a current pulse through said resistor
and said method further comprises:
measuring and increasing said passed current pulse until the resistance
of said resistor equals the target resistance.

1 9. A method of trimming a polysilicon resistor to a target resistance
2 formed using a low concentration doping as in claim 7 wherein the step of
3 passing a current pulse through said resistor is less than 20mA.

1 10. A method of trimming a polysilicon resistor to a target resistance
2 formed using a low concentration doping as in claim 7 wherein the step of
3 passing a current pulse through said resistor is done a voltage less than 16V.

1 11. A resistor having a resistance that can be adjusted by current
2 being passed there through and which is formed as part of a semiconductor
3 device comprising:

4 a polycrystalline silicon resistor formed of on a layer, wherein said
5 polysilicon resistor is formed using a doping wherein said doping has a
6 concentration of greater than $\sim 6 \times 10^{19} \text{ cm}^{-3}$.

1 12. A resistor having a resistance that can be adjusted by current
2 being passed there through and which is formed as part of a semiconductor
3 device comprising:

4 a polycrystalline silicon resistor formed of on a layer, wherein said
5 polysilicon resistor is formed using a late implant doping technique.

1 13. A method as in claim 3 wherein said final annealing step occurs
2 at or below 900 °C .

1 14. A method of trimming a polysilicon resistor to a target resistance
2 formed using a low concentration doping as in claim 7 wherein the electrical
3 signal that is passed is less than 16%.

1 15. A method as in claim 3 further comprising the step of forming a
 field oxide layer prior to the depositing of said polycrystalline layer.

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